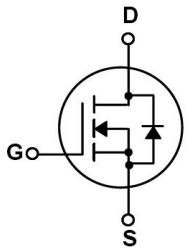
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DC/DC






## / $h_{FE}$ Classifications & Marking

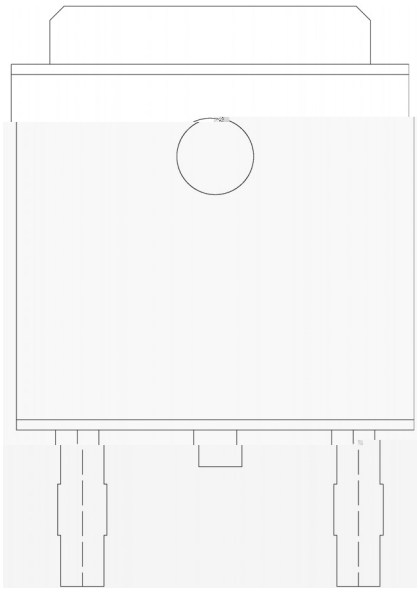
## / Package Dimensions




| | | | | | |
|---|---|---|---|---|---|
| | 0.90 | | | | |
| 00 | 0.10 | D1 | 5.10 | 5.50 | K |

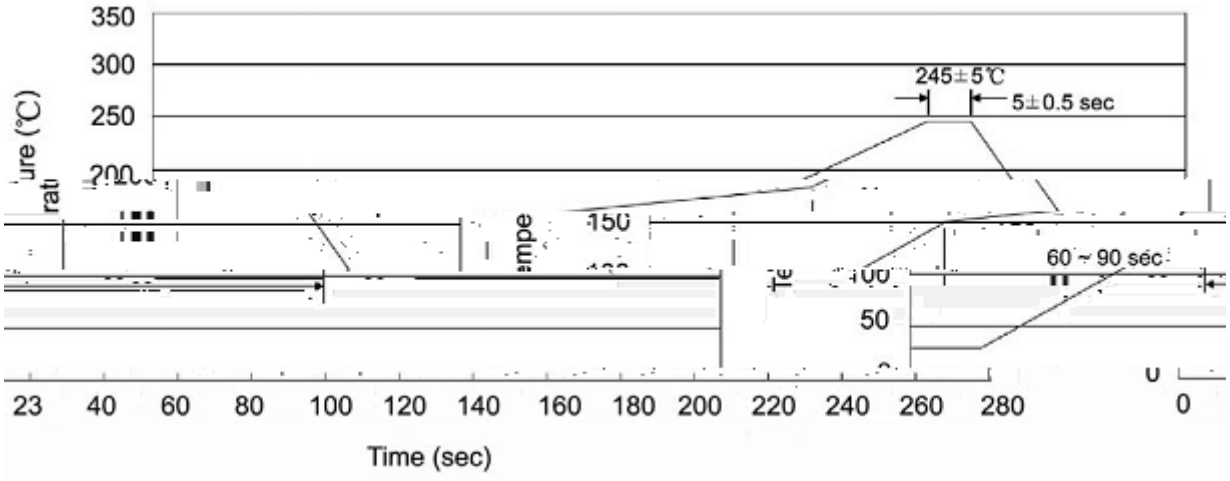
TO-252

## / Marking Instructions



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## ( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)




± ± ± ±

## / Resistance to Soldering Heat Test Conditions

± ±

## / Packaging SPEC.

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## / Notices